

12/13/05

ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of Invention

HIGH-PRESSURE PROCESSING CHAMBER FOR A
SEMICONDUCTOR WAFER

Application Number : 10/680783
 Confirmation Number: 5859
 First Named Applicant: William Jones
 Attorney Docket Number:
 Art Unit:
 Examiner:
 Search string: (6596093 or 20030196679).pn



Certification: This Information Disclosure Statement was submitted under the following conditions, which satisfies the requirement under 37 CFR 1.97(e). The filer certified:

That no item of information contained in the information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application, and, to the knowledge of the person signing the certification after making reasonable inquiry, no item of information contained in the information disclosure statement was known to any individual designated in 37 CFR 1.56(c) more than three months prior to the filing of the information disclosure statement.

US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
1W	1	6596093	2003-07-22	DeYoung et al.	B2		

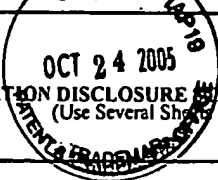
US Published Applications

Note: Applicant is not required to submit a paper copy of cited US Published Applications

init	Cite.No.	Pub. No.	Date	Applicant	Kind	Class	Subclass
1W	1	20030196679	2003-10-23	Cotte et al.	A1		

Signature

Examiner Name	Date
1W	11/24/06

FORM PTO-1449 (Modified)				U.S. Department of Commerce Patent and Trademark Office		Attorney Docket No.: SSI-04001		Serial No.: 10/680,783	
INFORMATION DISCLOSURE STATEMENT BY APPLICANT (Use Several Sheets If Necessary)						Applicant: William Dale Jones			
(37 CFR § 1.98(b))						Filing Date: October 6, 2003		Group Art Unit: 1763	

U.S. PATENT DOCUMENTS							
Examiner Initials	Serial / Patent Number	Issue Date	Applicant / Patentee	Class	Subclass	Filing Date	
	AA						
	AB						
	AC						
	AD						
	AE						
	AF						
	AG						
	AH						
	AI						
	AJ						

FOREIGN PATENTS OR PUBLISHED FOREIGN PATENT APPLICATIONS								
	Document Number	Publication Date	Country / Patent Office	Class	Subclass	Translation		
						Yes	No	
AK	JP 4-284648	10/09/92	Japan	H01L	21/68		X	
AL	JP 62-111442	05/22/87	Japan	H01L	21/68		X	
AM	JP 63-256326	10/24/88	Japan	B23Q	3/08		X	
AN								
AO								

OTHER DOCUMENTS (Including Author, Title, Date, Relevant Pages, Place of Publication)	
AP	
AQ	
AR	
AS	
AT	
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AY	
AZ	

Examiner: <i>h h h</i>	Date Considered: <i>1/24/06</i>
EXAMINER: Initial citation considered. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.	